Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

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Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,(automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN' s official sales channel").

It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.

Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.

Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

SMD INDUCTORS LARGE CURRENT SHIELD TYPE

APPLICATIONS

as PDP TV, LCD TV, HDD, PC, etc.

Power supply circuits / DC-DC converters in a variety of applications such



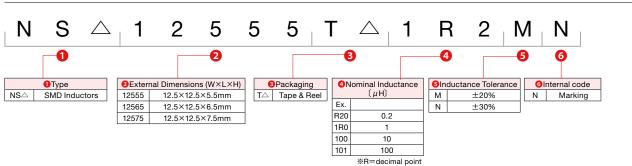
FEATURES

- SMD inductor.
- Low Rdc and high current
- Magnetic shield structure

OPERATING TEMPERATURE RANGE

• $-40^{\circ}C \sim 125^{\circ}C$ (Including self-generated heat)

ORDERING CODE



EXTERNAL DIMENSIONS/STANDARD QUANTITY

12.5±0.3

(0.492±0.012)

12.5±0.3

 (0.492 ± 0.012)

12.5±0.3

 (0.492 ± 0.012)

5.5±0.35

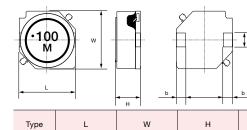
(0.217±0.014)

6.5±0.35

 (0.256 ± 0.014)

 7.5 ± 0.35

 (0.295 ± 0.014)



Recommended Land Patterns Surface Mounting •Mounting and soldering conditions should be checked beforehand. •Applicable soldering process to these products is reflow soldering only.

h

2.0±0.15

(0.079±0.006)

2.0±0.15

 (0.079 ± 0.006)

 $2.0 {\pm} 0.15$

 (0.079 ± 0.006)

Standard Quantity [pcs] Tape & Reel

500

Unit: mm(inch)

Unit : mm

а

3.0±0.1

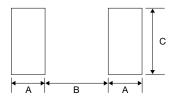
(0.118±0.004)

3.0±0.1

 (0.118 ± 0.004)

 $3.0{\pm}0.1$

 (0.118 ± 0.004)



Туре	А	В	С
NS12555	2.5	8.6	3.2
NS12565	2.5	8.6	3.2
NS12575	2.5	8.6	3.2
-			Unit : mm

12.5±0.3

(0.492±0.012)

12.5±0.3

 (0.492 ± 0.012)

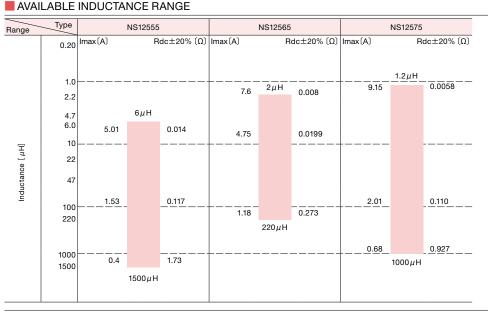
12.5±0.3

 (0.492 ± 0.012)

NS12555

NS12565

NS12575



PART NUMBERS

NS12555 type

	Inductance	Inductance	Self-resonant	DC Resistance	Rated curr	rent ※) [A]	Measuring
Ordering code	[µH]	Tolerance	frequency [MHz] (min.)	[Ω] (±20%)	Saturation current Idc1	Temperature rise current Idc2	frequency [kHz]
NS12555T6R0NN	6.0	±30%	26.4	0.0140	5.01	5.60	
NS12555T100MN	10		21.8	0.0175	4.73	5.04	
NS12555T150MN	15		16.6	0.0233	3.89	4.18	
NS12555T220MN	22		13.2	0.0297	3.20	3.81	
NS12555T330MN	33		10.8	0.0415	2.64	3.16	
NS12555T470MN	47		9.3	0.0551	2.23	2.70	
NS12555T680MN	68		7.9	0.0797	1.81	2.14	
NS12555T101MN	100	±20%	6.7	0.117	1.53	1.86	100
NS12555T151MN	150	120%	5.1	0.176	1.22	1.43	
NS12555T221MN	220		4.4	0.270	1.00	1.18	
NS12555T331MN	330		3.4	0.410	0.82	0.96	
NS12555T471MN	470		2.8	0.520	0.68	0.80	
NS12555T681MN	680		2.5	0.760	0.60	0.72	
NS12555T102MN	1000		2.0	1.120	0.47	0.59	
NS12555T152MN	1500		1.7	1.730	0.40	0.44	

NS12565 type

	Inductance	Inductance	Self-resonant	DC Resistance	Rated curr	rent ※) [A]	Measuring
Ordering code	[µH]	Tolerance	frequency [MHz] (min.)	[Ω] (±20%)	Saturation current Idc1	Temperature rise current Idc2	frequency [kHz]
NS12565T2R0NN	2.0		82.3	0.0080	13.91	7.60	
NS12565T4R2NN	4.2	±30%	41.5	0.0126	10.15	5.91	
NS12565T7R0NN	7.0		24.6	0.0162	7.93	5.21	
NS12565T100MN	10		15.8	0.0199	6.96	4.75	
NS12565T150MN	15		14.4	0.0237	5.84	4.33	
NS12565T220MN	22		12.5	0.0310	4.87	3.91	100
NS12565T330MN	33		9.1	0.0390	3.89	3.22	100
NS12565T470MN	47	±20%	7.2	0.0575	3.34	2.78	
NS12565T680MN	68		6.7	0.0775	2.78	2.30	
NS12565T101MN	100		5.5	0.1230	2.23	1.81	
NS12565T151MN	150		4.8	0.1730	1.84	1.54	
NS12565T221MN	220		3.6	0.2730	1.39	1.18	

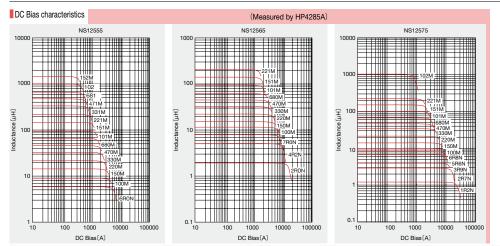
NS12575 type

	Inductance	Inductance	Self-resonant	DC Resistance	Rated curr	rent ※) [A]	Measuring
Ordering code	[µH]	Tolerance	frequency [MHz] (min.)	[Ω] (±20%)	Saturation current Idc1	Temperature rise current Idc2	frequency [kHz]
NS12575T1R2NN	1.2		101.7	0.0058	18.08	9.15	
NS12575T2R7NN	2.7		55.9	0.0085	13.91	7.69	
NS12575T3R9NN	3.9	±30%	41.7	0.0099	12.52	7.38	
NS12575T5R6NN	5.6		26.2	0.0116	10.85	6.36	
NS12575T6R8NN	6.8		24.0	0.0131	10.02	5.84	
NS12575T100MN	10		21.5	0.0156	7.65	5.55	
NS12575T150MN	15		14.0	0.0184	6.54	5.22	
NS12575T220MN	22		9.7	0.0260	5.56	4.05	100
NS12575T330MN	33		8.2	0.0390	4.45	3.48	
NS12575T470MN	47	+00%	6.5	0.0515	3.76	2.95	
NS12575T680MN	68	±20%	5.3	0.0720	2.78	2.49	
NS12575T101MN	100		3.9	0.1100	2.64	2.01	
NS12575T151MN	150		3.4	0.1610	2.09	1.51	
NS12575T221MN	220		2.9	0.2450	1.81	1.35	
NS12575T102MN	1000		1.4	0.9270	0.80	0.68	

*) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

**) The temperature rise current value (ldc2) is the DC current value having temperature increase up to 40°C. (at 20°C)
 **) The rated current is the DC current value that satisfies both of current value saturation current value and temperature rise current value.

ELECTRICAL CHARACTERISTICS

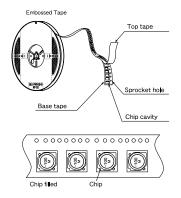


PACKAGING

1Packing Quantity

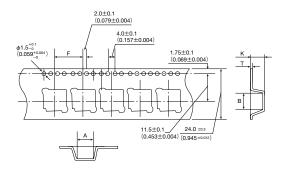
Turne	Standard Quantity [pcs]			
Туре	Paper Tape	Embossed Tape		
NS12555	—	500		
NS12565	—	500		
NS12575	_	500		

②Tape Material

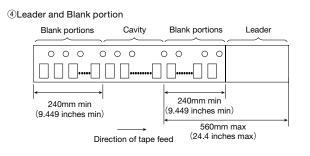


③Taping dimensions

Embossed tape 24mm wide (0.945 inches wide)



Туре	Chip	cavity	Insertion pitch	Tape thickness		
Type	А	В	F	Т	К	
NS12555	13.0±0.1	13.0±0.1	16.0±0.1	0.4±0.1	6.1±0.1	
	(0.512±0.004)	(0.512±0.004)	(0.630±0.004)	(0.016±0.004)	(0.240±0.004)	
NS12565	13.0±0.1	13.0±0.1	16.0±0.1	0.4±0.1	7.1±0.1	
	(0.512±0.004)	(0.512±0.004)	(0.630±0.004)	(0.016±0.004)	(0.280±0.004)	
NS12575	13.0±0.1	13.0±0.1	16.0±0.1	0.4±0.1	8.0±0.1	
	(0.512±0.004)	(0.512±0.004)	(0.630±0.004)	(0.016±0.004)	(0.315±0.004)	
	Unit : mm (inch)					

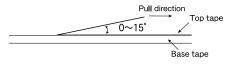


⑤Reel size 24.5+2/-0 (0.965+0.079/-0) 2±0.5-(0.079±0.020) đ pφ $\phi_{13\pm0.2}$ (φ0.512±0.004) Reel size (Reference values) Туре φD φd t (max.) NS12555/ NS12565/ 330±2 100±1 30.5 (1.201) (12.99±0.079) (3.937±0.039) NS12575

Unit : mm (inch)

6 Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



RELIABILITY DATA

Wound Chip power inductor (NR, N	(S-series)
1. Operating Temperature Range	
NR30/40/50/60/80, NRV30, NRH24/30,	-25~+120°C
NRS40/50/60/80 Type	
NR10050 Type	-25~+105℃ -40~+125℃
NS12555, NS12565, NS12575Type Test Method and Remarks	-40~+123.0
Including self-generated heat	
0. Otomore Terrer custure Denne	
2. Storage Temperature Range NR30/40/50/60/80, NRV30, NRH24/30,	T
NRS40/50/60/80 Type	
NR10050 Type	
NS12555, NS12565, NS12575Type	
[Test Method and Remarks]	IRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : −5 to 40°C for the product with taping.
NR30/40/30/60/80, NRV30, NRR24/30, N	
3. Rated current	
NR30/40/50/60/80, NRV30, NRH24/30,	
NRS40/50/60/80 Type	Within the specified tolerance
NR10050 Type NS12555, NS12565, NS12575Type	-
No12333, No12303, No123731ype	
4. Inductance	
NR30/40/50/60/80, NRV30, NRH24/30,	
NRS40/50/60/80 Type NR10050 Type	Within the specified tolerance
NS12555, NS12565, NS12575Type	1
[Test Method and Remarks]	
LCR Meter : HP 4285A or equivalent, M	Measuring frequency : Specified frequency
NR30/40/50/60/80, NRV30, NRH24/30, N NR10050 Type	IRS40/50/60/80 Type, NS12555, NS12565, NS12575Type:LCR Meter : HP 4285A or equivalent, 100KHz, 1V : LCR Meter : HP 4263A or equivalent, 100KHz, 1V
5. DC Resistance	
NR30/40/50/60/80, NRV30, NRH24/30,	
NRS40/50/60/80 Type	Within the specified tolerance
NR10050 Type	
NS12555, NS12565, NS12575Type [Test Method and Remarks]	
DC ohmmeter : HIOKI 3227 or equivale	unt contraction of the second
6. Self resonance frequency	
NR30/40/50/60/80, NRV30, NRH24/30,	
NRS40/50/60/80 Type	Within the specification
NR10050 Type	
NS12555, NS12565, NS12575Type [Test Method and Remarks]	
	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type:
Inpedance analyzer/material analyze	er : HP4291A or equivalent HP4191A, 4192A or equivalent
7. Temperature characteristic	
NR30/40/50/60/80, NRV30, NRH24/30,	T
NRS40/50/60/80 Type	Inductance change : Within ±20%
NR10050 Type	
NS12555, NS12565, NS12575Type	Inductance change : Within ±15%
[Test Method and Remarks]	NRS40/50/60/80 Type, NR10050 Type : Measurement of inductance shall be taken at temperature range within $-25^\circ\!C\!\!\sim\!+85^\circ\!C$.
NN30/40/30/00/80, NNV30, NN124/30,	With reference to inductance value at +20°C, change rate shall be calculated.
NS12555, NS12565, NS12575Type :	Measurement of inductance shall be taken at temperature range within $-40^{\circ}C \sim +125^{\circ}C$.
Change of maximum inductance de	With reference to inductance value at +20°C., change rate shall be calculated. viation in step 1 to 5
Temperature at step 1 20°C	
	n operating temperature
Temperature at step 3 20°C (Sta	andard temperature)
	n oparating temperature
Temperature at step 5 20°C	
8. Resistance to flexure of substrate	
NR30/40/50/60/80, NRV30, NRH24/30,	No damage
NRS40/50/60/80 Type	
NR10050 Type NS12555, NS12565, NS12575Type	No damage
Test Method and Remarks	
NR30/40/50/60/80, NRV30, NRH24/30,	NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type :
The test samples shall be soldered reaches to 2 mm.	to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board
Test board size : 100×40	
Test board material : glass ep	
	30/40, NRS40, NRH24/30, NRV30) 50/60/80, NRS40/50/60, NS12555, NS12565, NS12575Type) → ^L Bestandel[]
0.13 (146	B3/100/00, NH340/30/00, NB12333, NB12303, NB123731906)
Land dimension (NRH24) Land dimension (NR30	المحت حا (NRH30, NRI30) Land dimension (NR40, NRS40) Land dimension (NR50, NRS50) Land dimension (NR60, NRS60) Land dimension (NR80) Land dimension (NS12555/NS1255/NS1255/NS12555/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/NS1255/
	> < > <>
	Unit : mm
	ication only due to the limitation of space. When you consider the purchase of our products, please check our specification.

* This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

TAIYO YUDEN 2010

9. Insulation resistance : be	etween wires	3
NR30/40/50/60/80, NRV30,	NRH24/30,	
NRS40/50/60/80 Type		
NR10050 Type NS12555, NS12565, NS12575	Tuno	
10312000, 10312000, 10312070	туре	
10. Insulation resistance : b	botwoon wire	and core
NR30/40/50/60/80, NRV30,		a and core
NRS40/50/60/80 Type	NNN24/30,	
NR10050 Type		
NS12555, NS12565, NS12575	бТуре	
11. Withstanding voltage : I	between wire	e and core
NR30/40/50/60/80, NRV30,	NRH24/30,	
NRS40/50/60/80 Type		
NR10050 Type		
NS12555, NS12565, NS12575	Туре	
12. Adhesion of terminal ele		
NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type	NKH24/30,	
NR10050 Type		Shall not come off PC board
NS12555, NS12565, NS12575	Туре	
Test Method and Remarks		1
NR30/40/50/60/80, NRV30,	NRH24/30, N	NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
		o the test board by the reflow. and Y directions.
 Applied force Duration 	: 10IN to X	
 Solder cream thickness 		□ ● 10N, 5s
NR10050 Type :		
•Applied force : 5N to X	and Y direct	tions.
Duration : 5s.		
13. Resistance to vibration		
NR30/40/50/60/80, NRV30,	NRH24/30,	
NRS40/50/60/80 Type		Inductance change:Within ±10% No significant abnormality in appearance.
••	Type	no significant abrothanty in appearance.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30,	NRH24/30, N	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range	NRH24/30, N e soldered to d to below to 10~55Hz	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude	NRH24/30, N e soldered to ed to below to 10~55Hz 1.5mm (May	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ²)
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range	NRH24/30, N e soldered to ed to below to 10~55Hz 1.5mm (May	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude	NRH24/30, N e soldered to ed to below te 10~55Hz 1.5mm (May 10Hz to 55H X Y Fo	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ²)
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method	NRH24/30, N e soldered to ed to below to 10~55Hz 1.5mm (May 10Hz to 55H X	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : bet test board by the reflow. est conditions. y not exceed acceleration 196m/s ³) tz to 10Hz for 1min.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time	NRH24/30, N e soldered to do below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Z Fo Z	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : bet etest board by the reflow. est conditions. y not exceed acceleration 196m/s ³) tz to 10Hz for 1min.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs	NRH24/30, N e soldered to do below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Z Fo Z	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : bet conditions. y not exceed acceleration 196m/s ²) 4z to 10Hz for 1min. r 2 hours on each X, Y, and Z axis.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability	NRH24/30, N NRH24/30, N e soldered to below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Z Fo Z	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : bet conditions. y not exceed acceleration 196m/s ²) 4z to 10Hz for 1min. r 2 hours on each X, Y, and Z axis.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30,	NRH24/30, N NRH24/30, N e soldered to below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Z Fo Z	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : bet conditions. y not exceed acceleration 196m/s ²) 4z to 10Hz for 1min. r 2 hours on each X, Y, and Z axis.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type	NRH24/30, N NRH24/30, N e soldered to below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Z Fo Z	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : bet conditions. y not exceed acceleration 196m/s ²) 4z to 10Hz for 1min. r 2 hours on each X, Y, and Z axis.
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type NR10050 Type	NRH24/30, N e soldered to below te 10~55Hz 1.5mm (May 10Hz to 55H X Y Fo Z so f recovery	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ²) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs.
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NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR30/40/50/60/80 Type NR10050 Type NS12555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution	NRH24/30, N NRH24/30, N e soldered to below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Fo Z NRH24/30, NRH24/30, Type I e dipped in f o containing r	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ⁶) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. hux, and then immersed in molten solder as shown in below table. rosin 25%.
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NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NS12555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature	NRH24/30, N NRH24/30, N e soldered to below to 10~55Hz 1.5mm (May 10Hz to 55H X Y Fo Z NRH24/30, NRH24/30, N 245±5°C	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ⁶) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. hux, and then immersed in molten solder as shown in below table. rosin 25%.
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NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NS12555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time	NRH24/30, N NRH24/30, N $10\sim 55Hz$ 1.5mm (May 10Hz to $55HXYFoZNRH24/30,NRH24/30, N245\pm5^{\circ}C5\pm 1.0 sec.$	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ²) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. flux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80, NRV30, NRS40/50/60/80, NRV30, NRS40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, Solder Temperature Time Ximmersion depth : All side 15. Resistance to soldering	NRH24/30, N e soldered to below to 10 \sim 55Hz 1.5mm (May 10Hz to 55H X Y Fo Z of recovery NRH24/30, he dipped in f o containing i NRH24/30, N 245 \pm 5°C 5 \pm 1.0 sec. as of mountii	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ²) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. flux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80, NRV30, NR540/50/60/80, NRV30, NR540/50/60/80, NS12555, The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time *Immersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30,	NRH24/30, N e soldered to below to 10 \sim 55Hz 1.5mm (May 10Hz to 55H X Y Fo Z of recovery NRH24/30, he dipped in f o containing i NRH24/30, N 245 \pm 5°C 5 \pm 1.0 sec. as of mountii	VRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : o the test board by the reflow. est conditions. y not exceed acceleration 196m/s ^o) 4z to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. flux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR340/50/60/80, NRV30, NR10555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time XIImmersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30, NR340/50/60/80, NRV30, NR340/50/50/50/50/50, NR340/50/50/50/50, NR340/50/50/50/50/50, NR340/50/50/50/50, NR340/50/50/50/50/50, NR340/50/50/50/50	$\begin{tabular}{ c c c c } & NRH24/30, NRH24/30, Network to be low to be l$	VRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : b the test board by the reflow. set conditions. y not exceed acceleration 196m/s [*]) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. lux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
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NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR340/50/60/80, NRV30, NR10050 Type NR10050 Type NR30/40/50/60/80, NRV30, Solder Temperature Time Xethanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time Xethanol solution NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR340/50/60/80, NRV30, NR540/50/60/80, NS12555, NS12555	NRH24/30, N NRH24/30, N e soldered to 10~55Hz 1.5mm (May 10Hz to 55F Y Y Fo Z s of recovery NRH24/30, NRH24/30, NRH24/30, N 245±5°C 5±1.0 sec. ss of mountin heat NRH24/30,	VRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : b the test board by the reflow. set conditions. y not exceed acceleration 196m/s [*]) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. lux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
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NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR540/50/60/80, NRV30, NR10550 Type NS12555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time XIImmersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV3	NRH24/30, N NRH24/30, N NRH24/30, N 10~55Hz 1.5mm (May 10Hz to 55F X Fo Z NRH24/30, NRH24/30, N 245±5°C 5±1.0 sec. as of mountil NRH24/30, NRH24/30, NRH24/30,	WRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : b the test board by the reflow. est conditions. /r not exceed acceleration 196m/s ²) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. lux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, Solder Temperature Time *Immersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60	NRH24/30, N NRH24/30, N NRH24/30, N 10~55Hz 1.5mm (May 10Hz to 55F X Fo Z NRH24/30, NRH24/30, N 245±5°C 5±1.0 sec. as of mountil NRH24/30, NRH24/30, NRH24/30,	WRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : b the test board by the reflow. est conditions. y not exceed acceleration 196m/s [*]) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. lux, and then immersed in molten solder as shown in below table. rosin 25%. VRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
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NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NRS40/50/60/80, NRV30, NR30/40/50/60/80, NS12555, NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, Solder Temperature Time */Immersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, The test sample shall be NR6020 Type : The test sample shall be	NRH24/30, N e soldered to below to 10~55Hz 1.5mm (May 10Hz to 55H X Fo Z sof recovery NRH24/30, NRH24/30, N 245±5°C 5±1.0 sec. ses of mountin heat NRH24/30, N RH24/30, N RH24/30, N RH24/30, N	WRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : the test board by the reflow. est conditions. y not exceed acceleration 196m/s ¹) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. Itux, and then immersed in molten solder as shown in below table. rosin 25%. NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR340/50/60/80, NRV30, NR1050 Type NS12555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time Xilmmersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, The test sample shall be NR6020 Type : The test sample shall be Test board thickness : 1.0m	NRH24/30, N NRH24/30, N NRH24/30, N 1.5mm (May 10Hz to 55F X Y Fo Z NRH24/30, N 245±5°C 5±1.0 sec. so f mountil NRH24/30, N 245±5°C 5±1.0 sec. NRH24/30, N NRH24/30, N 245±5°C 5±1.0 sec. so f mountil NRH24/30, N NRH24/30, N N NRH24/30, N N NRH24/30, N N NRH24/30, N N N N N N N N N N N N N N	NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : to the test board by the reflow. set conditions. rnot exceed acceleration 196m/s [*]) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. ilux, and then immersed in molten solder as shown in below table. rosin 25%. NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
NS12555, NS12565, NS12575 [Test Method and Remarks] NR30/40/50/60/80, NRV30, The test samples shall b Then it shall be submitte Frequency Range Total Amplitude Sweeping Method Time Recovery : At least 2hrs 14. Solderability NR30/40/50/60/80, NRV30, NR340/50/60/80, NRV30, NR1050 Type NS12555, NS12565, NS12575 [Test Method and Remarks] The test samples shall b Flux : Methanol solution NR30/40/50/60/80, NRV30, Solder Temperature Time Xilmmersion depth : All side 15. Resistance to soldering NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, NR30/40/50/60/80, NRV30, The test sample shall be NR6020 Type : The test sample shall be Test board thickness : 1.0m	NRH24/30, N NRH24/30, N e soldered to 10~55Hz 1.5mm (May 10Hz to 55F X Y Fo Z s of recovery NRH24/30, NRH24/30, 245±5°C 5±1.0 sec. ss of mountii heat NRH24/30, NRH24/30, Y NRH24/30, NRH24/30, NRH24/30, Stype NRH24/30,	WRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : b the test board by the reflow. est conditions. // not exceed acceleration 196m/s ²) tz to 10Hz for 1min. r 2 hours on each X, Y, and Z axis. under the standard condition after the test, followed by the measurement within 48hrs. At least 90% of surface of terminal electrode is covered by new solder. Itux, and then immersed in molten solder as shown in below table. rosin 25%. WRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :

RELIABILITY DATA

Wound Chip power inductor (NR, NS-series)

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16. Thermal shock					
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Inductance change:Within ±10%				
	No significant abnormality in appearance.				
NS12555, NS12565, NS12575Type					
[Test Method and Remarks]	NRS/10/50/60/80 Tune NR10050 Tune NS12555 NS12565 NS12575Tune ·				

30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.

	Conditions of 1 cycle					
Step	Temperature (°C)	Duration (min)				
1	-40±3	30±3				
2	Room temperature	Within 3				
3	+85±2	30±3				
4	Room temperature	Within 3				

17. Damp heat	
NR30/40/50/60/80, NRV30, NRH24/30,	Inductance change : Within ±10%
NRS40/50/60/80 Type	No significant abnormality in appearance.
NR10050 Type	
NS12555, NS12565, NS12575Type	Inductance change : Within ±10%
NS12555, NS12565, NS125751990	No significant abnormality in appearance.
[Test Method and Remarks]	

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type : The test samples shall be soldered to the test board by the reflow. The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.

Temperature	60±2°C			
Humidity	90~95%RH			
Time	500+24/-0 hour			

		iductance change : Within $\pm 10\%$ o significant abnormality in appearance.	
		The test samples s	hall be soldered to
Humidity	90~95%RH		
Applied current	Rated current		
Time	500+24/-0 hou		

19. Low temperature life test		
NR30/40/50/60/80, NRV30, NRH24/3 NRS40/50/60/80 Type	Inductance change : Within ±10%	
NR10050 Type	No significant abnormality in appearance.	
NS12555, NS12565, NS12575Type		
[Test Method and Remarks] NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type : The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.		
Temperature -40±2	c	
Time 500+24/-0	hour	

20. High temperature life test		life test	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type			
NR	10050 Type		Inductance change:Within ±10% No significant abnormality in appearance.
NS1	2555, NS12565, NS	12575Type	
	st Method and Ren 10050 Type :	narks	
	Temperature	105±3℃	
	Time	500+24/-0 ho	bur

Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.

21. Loading at high temperature life test	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Inductance change:Within ±10% No significant abnormality in appearance.
NR10050 Type	
	Inductance change:Within ±10% No significant abnormality in appearance.

[Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type : The test samples shall be soldered to the test board by the reflow soldering.

Temperature	85±2℃			
Applied current	Rated current			
Time	500+24/-0 hour			

Wound Chip power inductor (NR, NS-series)

22. Standard condition	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Standard test condition : Unless otherwise specified, temperature is 20±15°C and 65±20% of relative humidity. When there is any guestion concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2°C
NR10050 Type	of temperature, 65±5% relative humidity.
NS12555, NS12565, NS12575Type	Inductance is in accordance with our measured value.

PRECAUTIONS

Wound Chip power inductor (NR, NS-series)

Wound Chip	power inductor(NR, NS-series)
1. Circuit De	
Precautions	Operating environment The products described in this specification are intended for use in general electronic equipment, office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.
2. PCB Desi	gn
Precautions	◆Land pattern design
	1. Please refer to a recommended land pattern.
Technical consider- ations	Surface Mounting Mounting and soldering conditions should be checked beforehand. Applicable soldering process to this products is reflow soldering only.
3. Considera	tions for automatic placement
Precautions	 Adjustment of mounting machine 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards. 2. Mounting and soldering conditions should be checked beforehand.
Technical consider- ations	 Adjustment of mounting machine 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.
4. Soldering	
Precautions	 Reflow soldering Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified. The product shall be used reflow soldering only. Please do not add any stress to a product until it returns in normal temperature after reflow soldering. Lead free soldering When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently. Please contained conditions for using a soldering iron (NR10050 Type) Put the soldering iron on the land-pattern. Soldering iron's temperature - Below 350°C Duration - 3 seconds or less The soldering not directly touch the inductor.
Technical consider- ations	◆Reflow soldering If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products. NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050, NS12555, NS12565, NS12575 Type Recommended reflow condition (Pb free solder) ³⁰⁰ ¹⁵⁰ ¹⁵⁰
5. Cleaning	
Precautions	 ♦Cleaning conditions 1. Washing by supersonic waves shall be avoided.
Technical consider- ations	 Cleaning conditions 1. if washed by supersonic waves, the products might be broken.
utionio	
6. Handling	
Precautions	 ♦Handling Keep the product away from all magnets and magnetic objects. Breakaway PC boards (splitting along perforations) When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations Please do not give the product any excessive mechanical shocks. Please do not add any shock and power to a product in transportation. ♦Pick-up pressure Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ♦Packing Please avoid accumulation of a packing box as much as possible.
Technical consider- ations	 Breakaway PC boards (splitting along perforations) The position of the product on PCBs shall be carefully considereed to minimize the stress caused from splitting of the PCBs. Mechanical considerations There is a case to be damaged by a mechanical shock. There is a case to be damaged by a mechanical shock. There is a case to be broken by the handling in transportation. Pick-up pressure Damage and a characteristic can vary with an excessive shock or stress. Packing If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.
7. Storage c	
	 Storage To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. Recommended conditions
Precautions	 recommended conditions Ambient temperature: -5~40°C Humidity Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical consider- ations	 Storage Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.
* This catalo	g contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification.